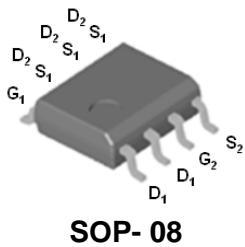


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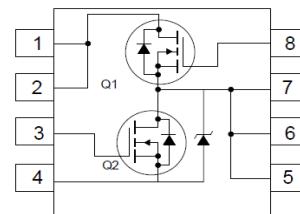
Dual N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

	$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
Q2	30V	15.8mΩ @ $V_{GS} = 10V$	9A
Q1	30V	21.0mΩ @ $V_{GS} = 10V$	8A



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ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage	V_{DS}	30	30	V
Gate-Source Voltage	V_{GS}	± 20	± 20	
Continuous Drain Current ²	I_D	9	8	A
		7	6	
Pulsed Drain Current ^{1, 2}	I_{DM}	35	30	A
Avalanche Current	I_{AS}	29	21	
Avalanche Energy	E_{AS}	43	23	mJ
Power Dissipation	P_D	2	1.28	W
		1.28		
Operating Junction & Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	Schottky	UNITS
Reverse Current	I_R	0.05	mA
Forward Voltage	V_F	0.45	V

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	R_{0JA}		62.5	°C / W

¹Pulse width limited by maximum junction temperature.

²Limited only by maximum temperature allowed

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Dual N-Channel Enhancement Mode MOSFET

Q2 ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.7	3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			10	
On-State Drain Current ¹	$I_{D(\text{ON})}$	$V_{DS} = 5V, V_{GS} = 10V$	35			A
Drain-Source On-State Resistance ¹	$R_{DS(\text{ON})}$	$V_{GS} = 4.5V, I_D = 7A$		14.2	20	$\text{m}\Omega$
		$V_{GS} = 10V, I_D = 9A$		10.5	15.8	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 9A$		25		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 15V, f = 1\text{MHz}$		1040		pF
Output Capacitance	C_{oss}			295		
Reverse Transfer Capacitance	C_{rss}			139		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1\text{MHz}$		1.5		Ω
Total Gate Charge ²	Q_g	$V_{DS} = 0.5V_{(\text{BR})\text{DSS}}, I_D = 9A, V_{GS} = 10V$		20		nC
Gate-Source Charge ²	Q_{gs}			3.8		
Gate-Drain Charge ²	Q_{gd}			4.3		
Turn-On Delay Time ²	$t_{d(\text{on})}$	$V_{DD} = 15V, I_D = 1A, V_{GS} = 10V, R_G = 6\Omega$		18		nS
Rise Time ²	t_r			12		
Turn-Off Delay Time ²	$t_{d(\text{off})}$			40		
Fall Time ²	t_f			8		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current	I_S				2.8	V
Forward Voltage ¹	V_{SD}	$I_F = 9A, V_{GS} = 0V$			0.7	V
Reverse Recovery Time	t_{rr}	$I_F = 9A, dI_F/dt = 100A/\mu\text{s}$		15		nS
Reverse Recovery Charge	Q_{rr}			6		nC

¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

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Dual N-Channel Enhancement Mode MOSFET

Q1 ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	2	3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	μA
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C			10	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 5V, V _{GS} = 10V	30			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 6A		25.6	32	mΩ
		V _{GS} = 10V, I _D = 7A		15.8	21	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 7A		15		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		560		pF
Output Capacitance	C _{oss}			160		
Reverse Transfer Capacitance	C _{rss}			84		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		2		Ω
Total Gate Charge ²	Q _g	V _{DS} = 0.5V _{(BR)DSS} , I _D = 7A, V _{GS} = 10V		11		nC
Gate-Source Charge ²	Q _{gs}			2.5		
Gate-Drain Charge ²	Q _{gd}			3.1		
Turn-On Delay Time ²	t _{d(on)}	V _{DD} = 15V, I _D = 1A, V _{GS} = 10V, R _G = 6Ω		19		nS
Rise Time ²	t _r			8		
Turn-Off Delay Time ²	t _{d(off)}			39		
Fall Time ²	t _f			6		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I _S				2	V
Forward Voltage ¹	V _{SD}	I _F = 7A, V _{GS} = 0V			1	V
Reverse Recovery Time	t _{rr}	I _F = 7A, dI _F /dt = 100A / μS		20		nS
Reverse Recovery Charge	Q _{rr}			12		nC

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

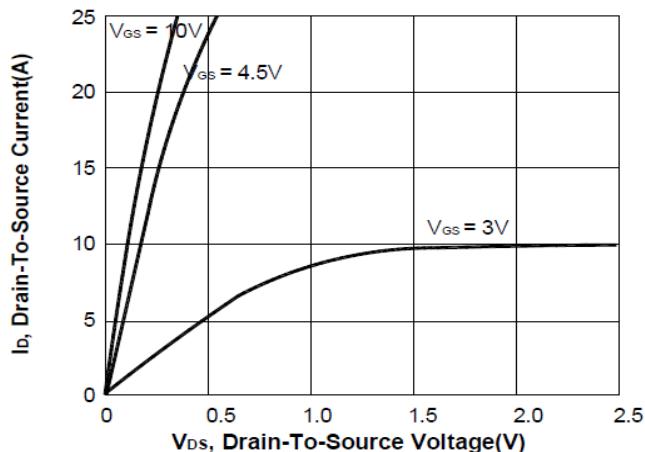
²Independent of operating temperature.

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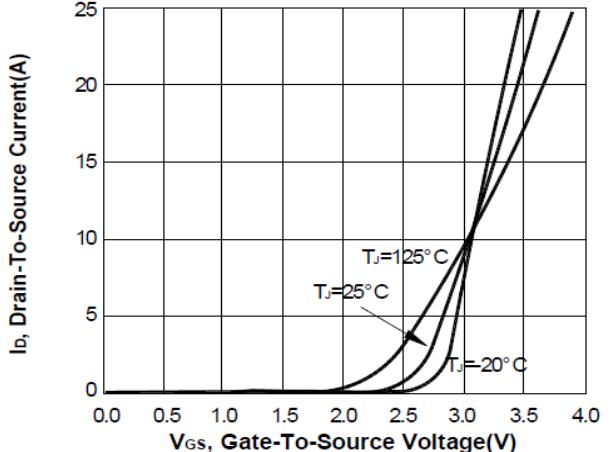
Dual N-Channel Enhancement Mode MOSFET

Typical Characteristics: Q2

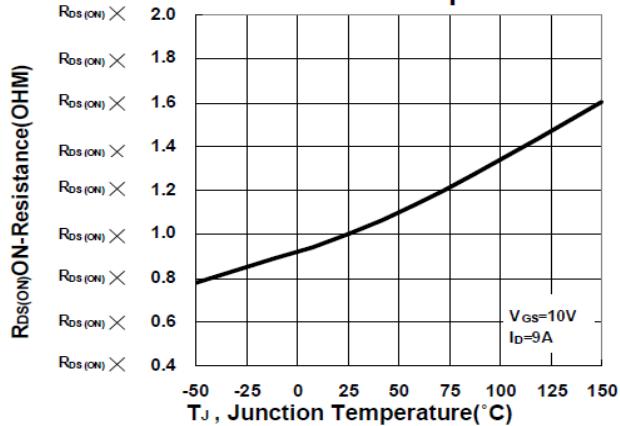
Output Characteristics



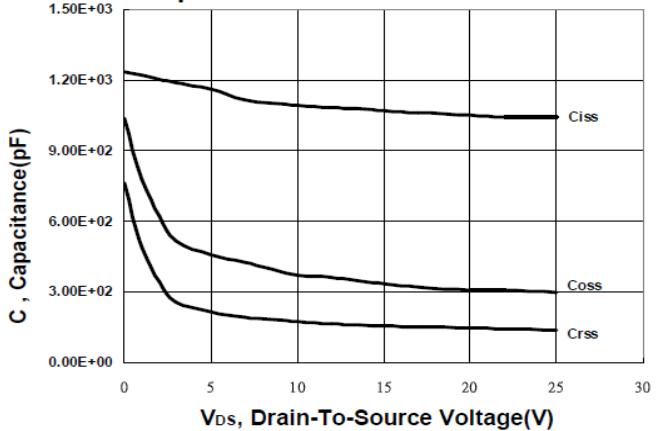
Transfer Characteristics



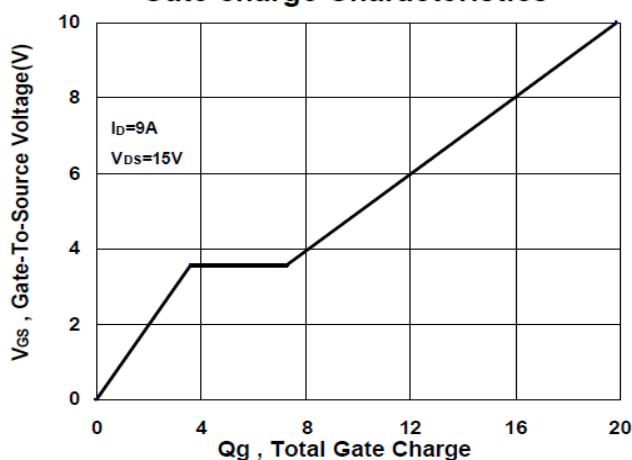
On-Resistance VS Temperature



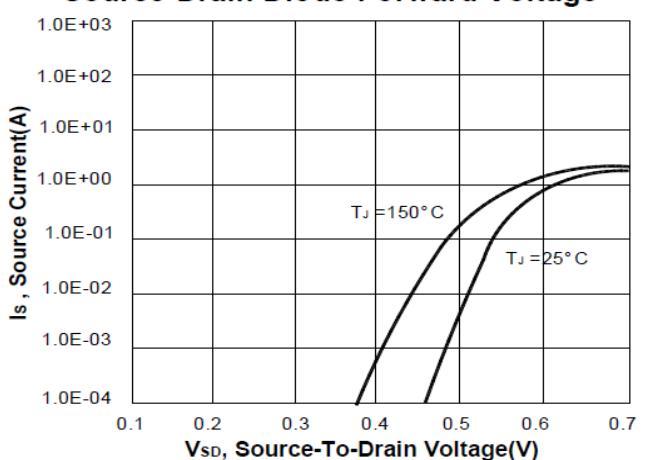
Capacitance Characteristic



Gate charge Characteristics

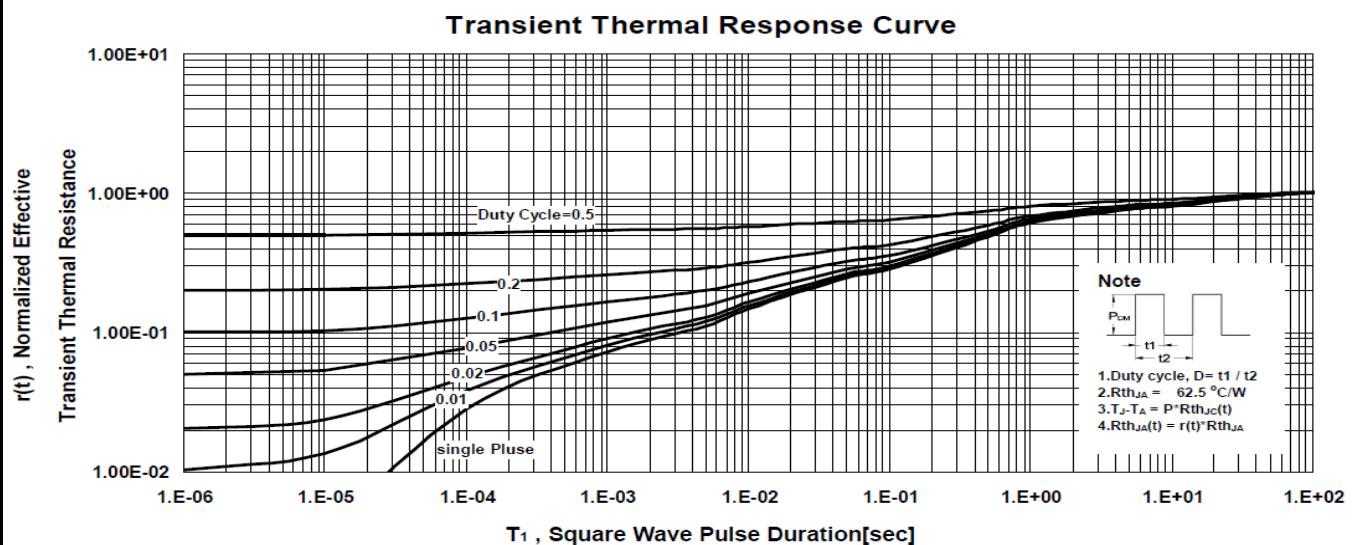
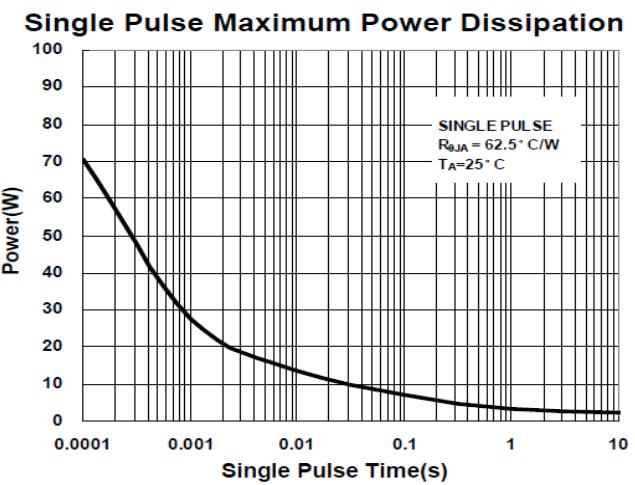
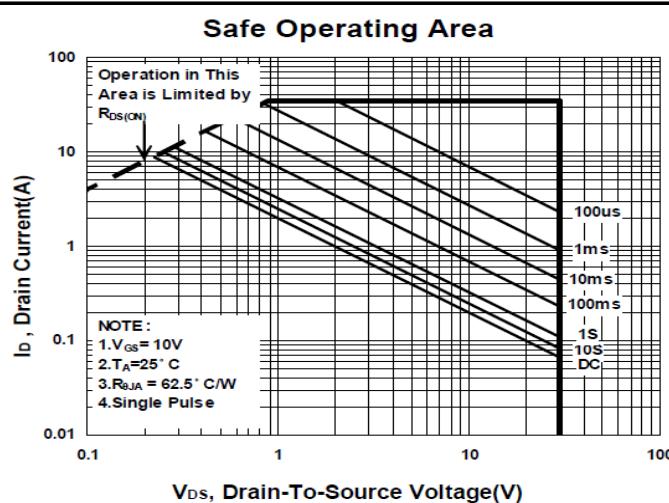


Source-Drain Diode Forward Voltage



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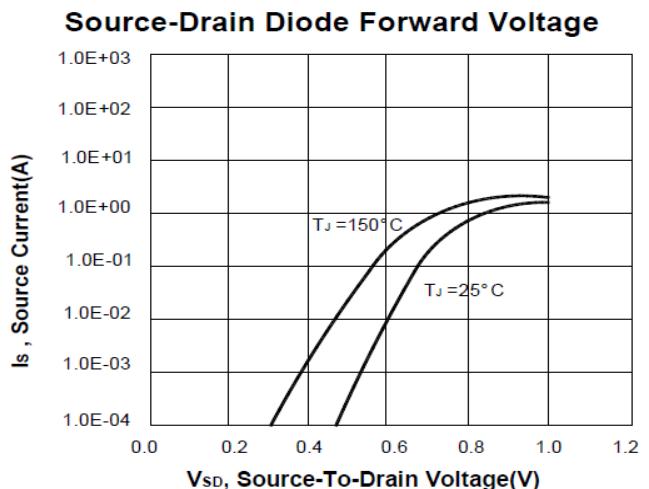
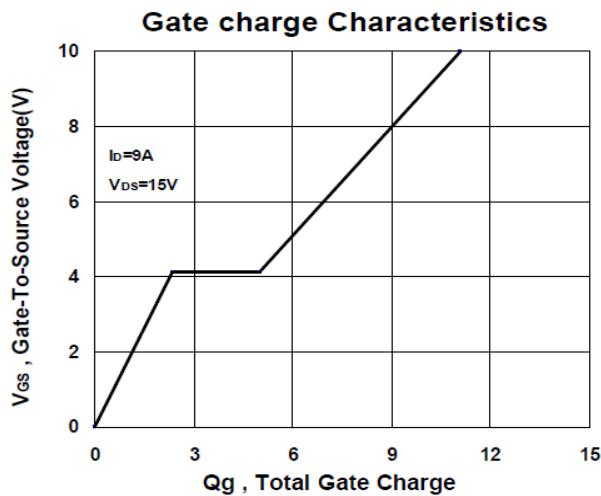
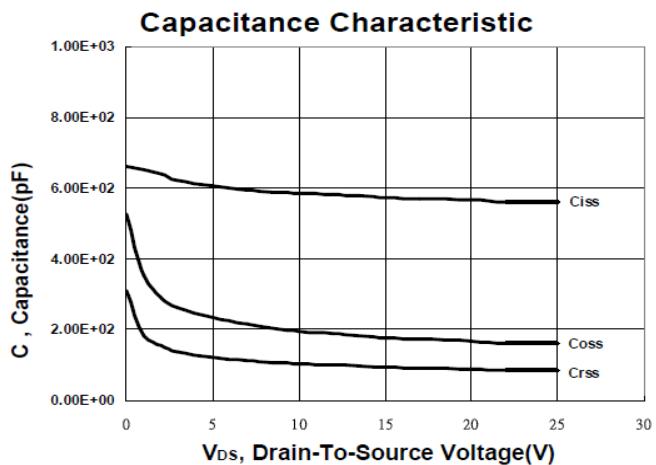
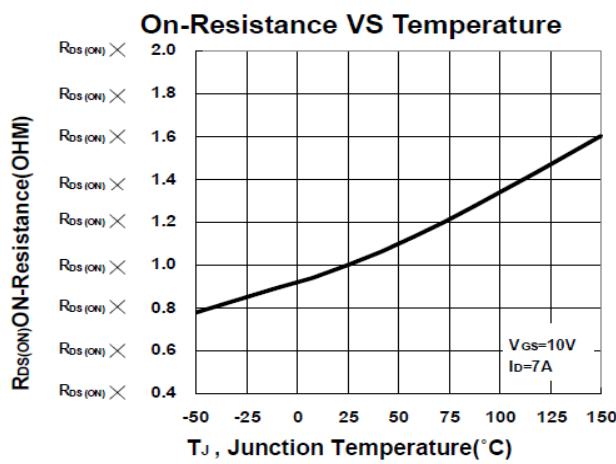
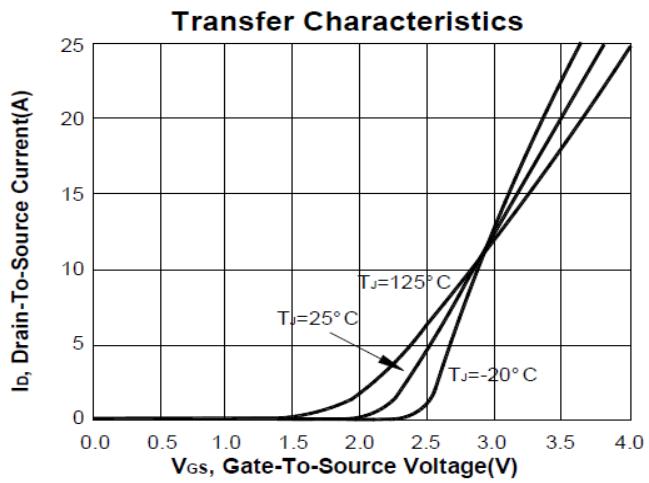
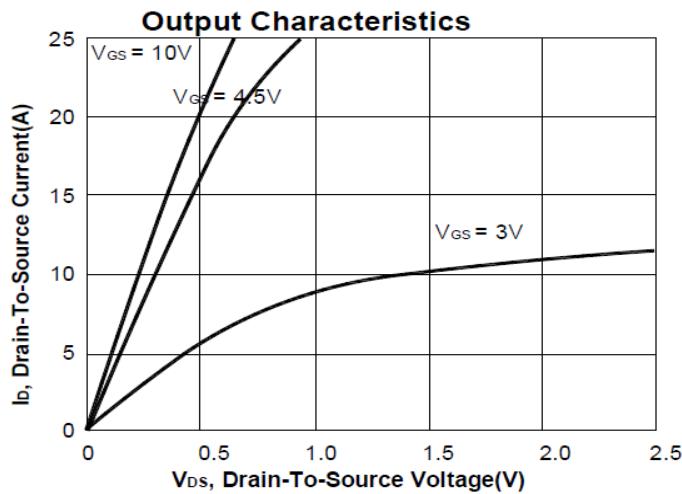
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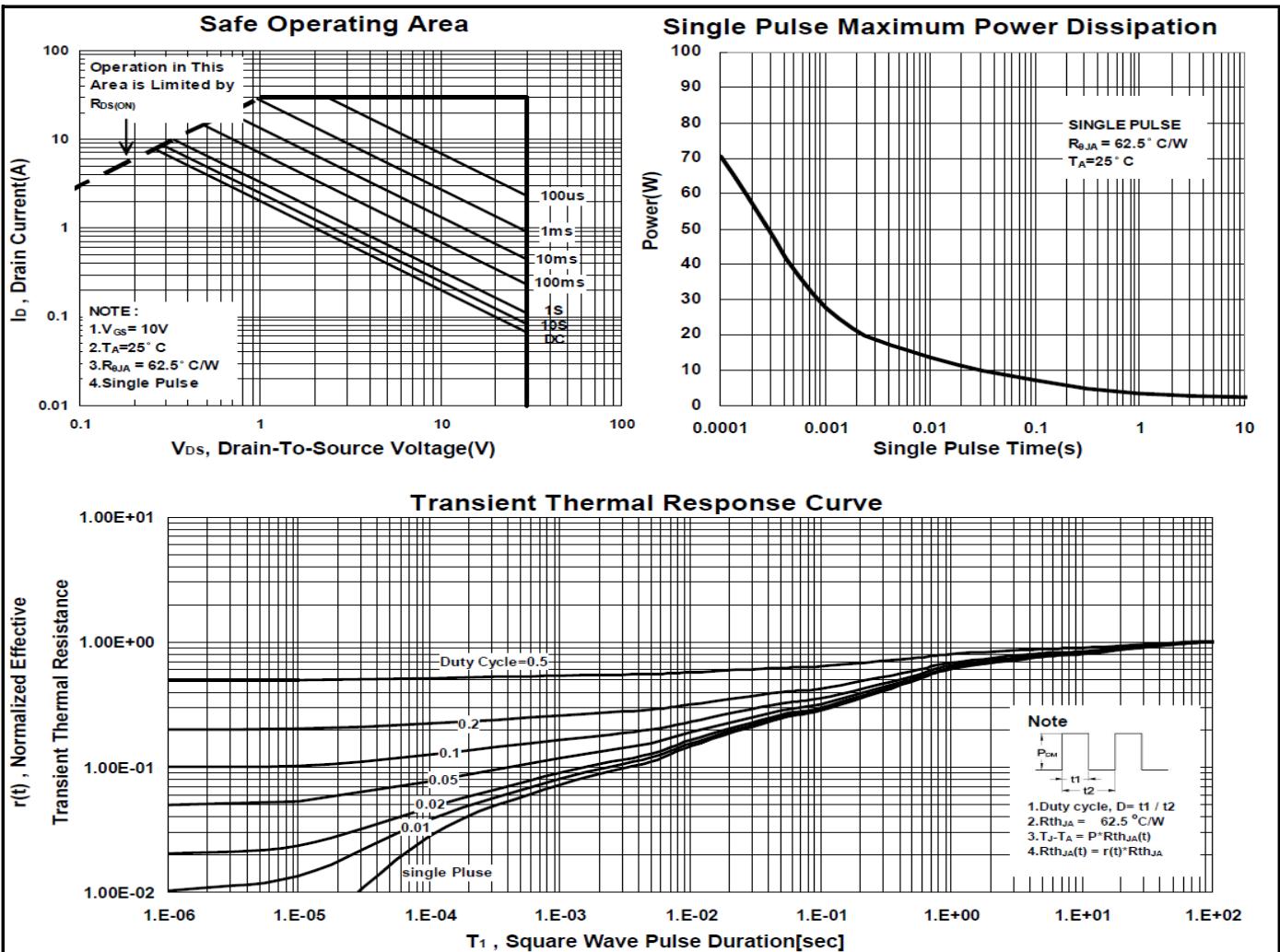
Dual N-Channel Enhancement Mode MOSFET

Typical Characteristics: Q1



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Dual N-Channel Enhancement Mode MOSFET



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Dual N-Channel Enhancement Mode MOSFET

Package Dimension

SOP-8 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.4	0.6	0.93
B	3.8	3.9	4.0	I	0.19	0.21	0.25
C	5.79	6.0	6.2	J	0.25	0.375	0.5
D	0.33	0.4	0.51	K	0°	3°	18°
E	1.25	1.27	1.29				
F	1.1	1.3	1.65				
G	0.05	0.15	0.25				

